

7WB3305

2-Bit Bus Switch

The 7WB3305 is an advanced high-speed low-power 2-bit bus switch in ultra-small footprints.

Features

- High Speed: $t_{PD} = 0.25$ ns (Max) @ $V_{CC} = 4.5$ V
- 3Ω Switch Connection Between 2 Ports
- Power Down Protection Provided on Inputs
- Zero Bounce
- TTL-Compatible Control Inputs
- Ultra-Small Pb-Free Packages
- These are Pb-Free Devices



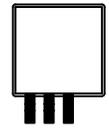
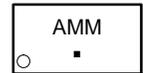
ON Semiconductor

<http://onsemi.com>

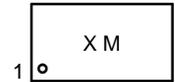
MARKING DIAGRAMS



**UDFN8
MU SUFFIX
CASE 517AJ**



**Micro8™
DM SUFFIX
CASE 846A**



A = Assembly Location

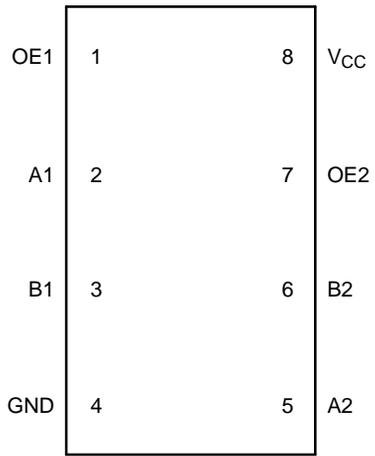
**UDFN8
1.95 x 1.0
CASE 517CA**

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

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MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage	-0.5 to +7.0	V
V_{IN}	Control Pin Input Voltage	-0.5 to +7.0	V
$V_{I/O}$	Switch Input / Output Voltage	-0.5 to +7.0	V
I_{IK}	Control Pin DC Input Diode Current $V_{IN} < GND$	-50	mA
I_{OK}	Switch I/O Port DC Diode Current $V_{I/O} < GND$	-50	mA
I_O	ON-State Switch Current	± 128	mA
	Continuous Current Through V_{CC} or GND	± 150	mA
I_{CC}	DC Supply Current Per Supply Pin	± 150	mA
I_{GND}	DC Ground Current per Ground Pin	± 150	mA
T_{STG}	Storage Temperature Range	-65 to +150	$^{\circ}C$
T_L	Lead Temperature, 1 mm from Case for 10 Seconds	260	$^{\circ}C$
T_J	Junction Temperature Under Bias	150	$^{\circ}C$
θ_{JA}	Thermal Resistance UDFN8 (Note 1) Micro8	111	$^{\circ}C/W$
		392	
P_D	Power Dissipation in Still Air at 85 $^{\circ}C$ UDFN8 Micro8	1127	mW
		319	
MSL	Moisture Sensitivity	Level 1	
F_R	Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
V_{ESD}	ESD Withstand Voltage Human Body Mode (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	> 2000	V
		> 200	
		N/A	
$I_{LATCHUP}$	Latchup Performance Above V_{CC} and Below GND at 125 $^{\circ}C$ (Note 5)	± 200	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow.
2. Tested to EIA / JESD22-A114-A.
3. Tested to EIA / JESD22-A115-A.
4. Tested to JESD22-C101-A.
5. Tested to EIA / JESD78.

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TYPICAL DC CHARACTERISTICS

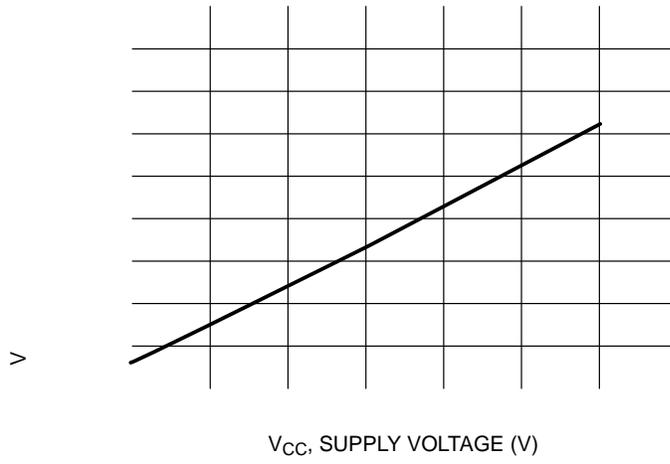


Figure 4. Output Voltage High vs Supply Voltage

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ORDERING INFORMATION

Device	Package	Shipping†
7WB3305MUTAG	UDFN8 (Pb-Free)	3000 / Tape & Reel
7WB3305DMR2G	Micro8 (Pb-Free)	4000 / Tape & Reel
7WB3305DMUTCG	UDFN8, 1.95 x 1.0, 0.5 mm Pitch (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

UDFN8 1.8x1.2, 0.4P
CASE 517AJ
ISSUE O

DATE 08 NOV 2006

SCALE 4:1



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION *b* APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL TIP.
4. MOLD FLASH ALLOWED ON TERMINALS ALONG EDGE OF PACKAGE. FLASH MAY NOT EXCEED 0.03 ONTO BOTTOM SURFACE OF TERMINALS.
5. DETAIL A SHOWS OPTIONAL CONSTRUCTION FOR TERMINALS.

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